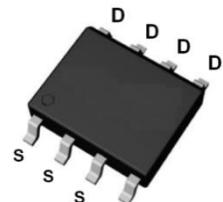


Lonten P-channel -30V, -6.5A, 46mΩ Power MOSFET

Description	Product Summary
<p>These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.</p>	<p>V_{DSS} -30V R_{DS(on).max}@ V_{GS}=-10V 46mΩ I_D -6.5A</p>
Features	Pin Configuration
<ul style="list-style-type: none"> ◆ -30V,-6.5A,R_{DS(ON).max}=46mΩ@V_{GS}=-10V ◆ Improved dv/dt capability ◆ Fast switching ◆ Green device available 	 SOP-8
Applications	P-Channel MOSFET
<ul style="list-style-type: none"> ◆ PWM applications ◆ Load switch ◆ Portable Equipment 	

Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	-30	V
Continuous drain current (T _A = 25°C)	I _D	-6.5	A
		-4.1	A
Pulsed drain current ¹⁾	I _{DM}	-26	A
Gate-Source voltage	V _{GSS}	±20	V
Power Dissipation (T _A = 25°C)	P _D	2.9	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	T _J	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R _{θJA}	43	°C/W

Package Marking and Ordering Information

Device	Device Package	Marking
LPL4459	SOP-8	LPL4459

Electrical Characteristics

T_J = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =-250μA	-30	---	---	V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1.2	-1.7	-2.2	V
Drain-source leakage current	I _{DSS}	V _{DS} =-30 V, V _{GS} =0 V, T _J = 25°C	---	---	-1	μA
		V _{DS} =-24V, V _{GS} =0 V, T _J = 125°C	---	---	-10	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V	---	---	100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V	---	---	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =-10 V, I _D =-6.5 A	---	33	46	mΩ
		V _{GS} =-4.5 V, I _D =-5A	---	43	72	mΩ
Forward transconductance	g _f	V _{DS} =-5 V , I _D =-6.5A	---	17	---	S
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} = -15 V, V _{GS} = 0 V, F = 1MHz	---	940	---	pF
Output capacitance	C _{oss}		---	103	---	
Reverse transfer capacitance	C _{rss}		---	88	---	
Turn-on delay time	t _{d(on)}	V _{DD} =-15V,V _{GS} =-10V,I _D =-6.5A, Rg=3Ω	---	3.9	---	ns
Rise time	t _r		---	33.2	---	
Turn-off delay time	t _{d(off)}		---	39.3	---	
Fall time	t _f		---	9.2	---	
Gate resistance	R _g	V _{GS} =0V,V _{DS} =0V,f=1MHz	---	11	---	Ω
Gate charge characteristics						
Gate to source charge	Q _{gs}	V _{DS} =-15 V, I _D =-6.5A, V _{GS} =-10 V	---	2.44	---	nC
Gate to drain charge	Q _{gd}		---	2.92	---	
Gate charge total	Q _g		---	14.6	---	
Drain-Source diode characteristics and Maximum Ratings						
Continuous Source Current	I _S	V _{GS} =0V, I _S =-1A, T _J =25°C	---	---	-6.5	A
Pulsed Source Current ²⁾	I _{SM}		---	---	-26	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-1A, T _J =25°C	---	---	-1.2	V

Notes:

1: Repetitive Rating: Pulse width limited by maximum junction temperature.

2: Pulse Test: Pulse Width ≤300 μ s, Duty Cycle≤2%.

Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

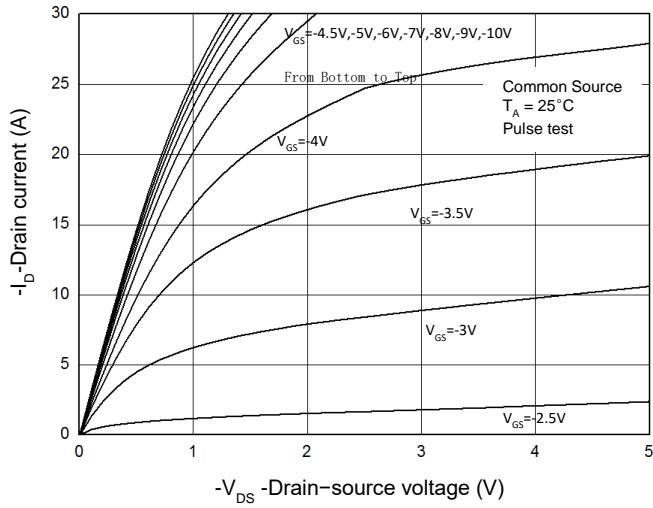


Figure 2. Transfer Characteristics

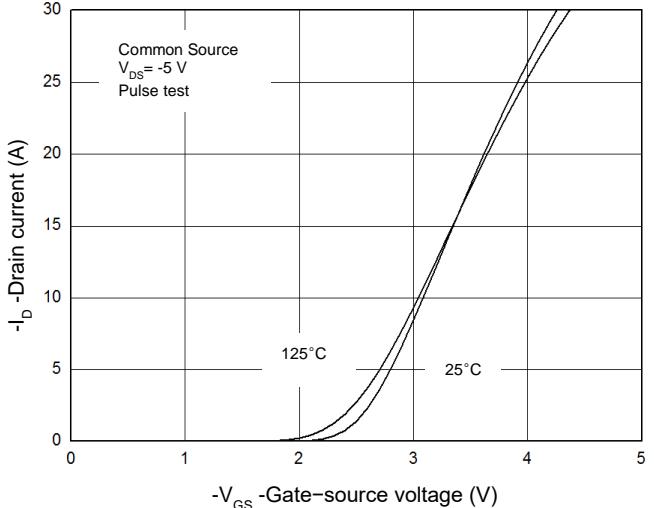


Figure 3. Capacitance Characteristics

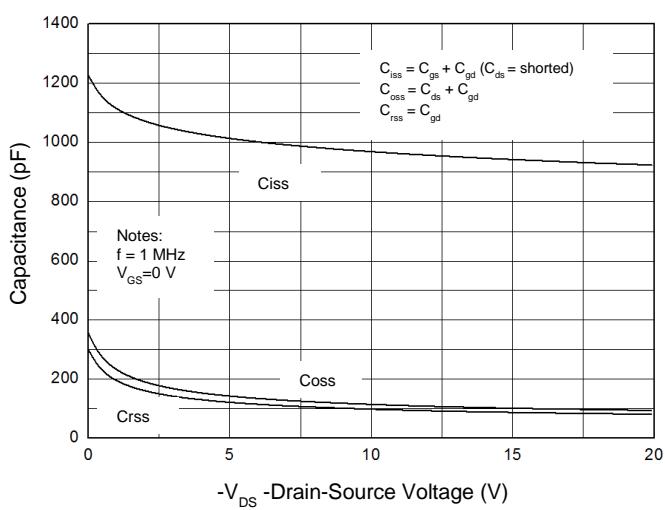


Figure 4. Gate Charge Waveform

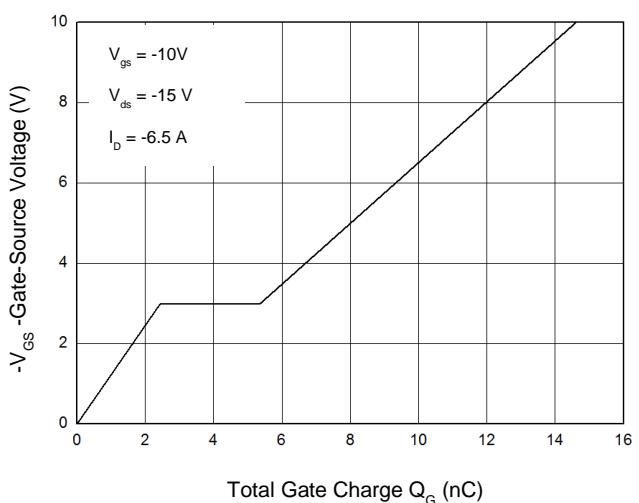


Figure 5. Body-Diode Characteristics

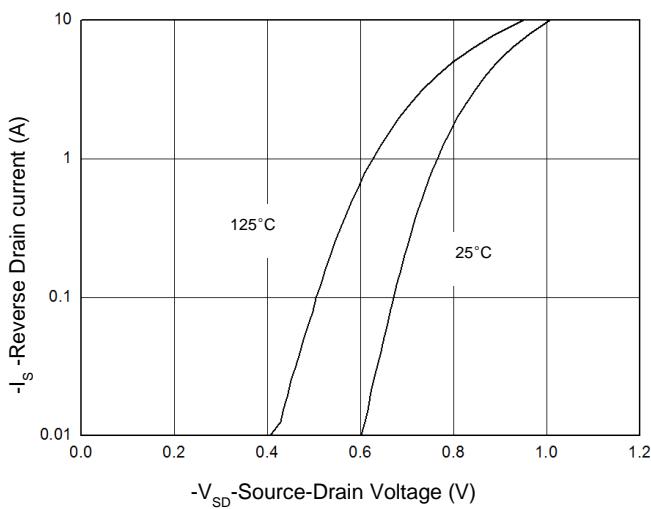


Figure 6. Rdson-Drain Current

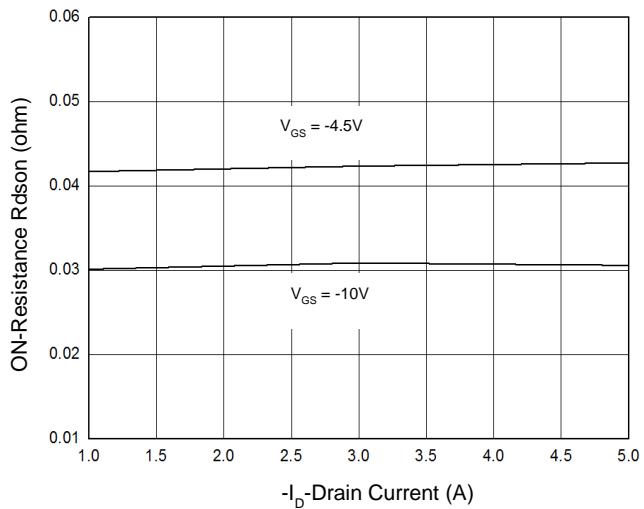


Figure 7. Rdson-Junction Temperature(°C)

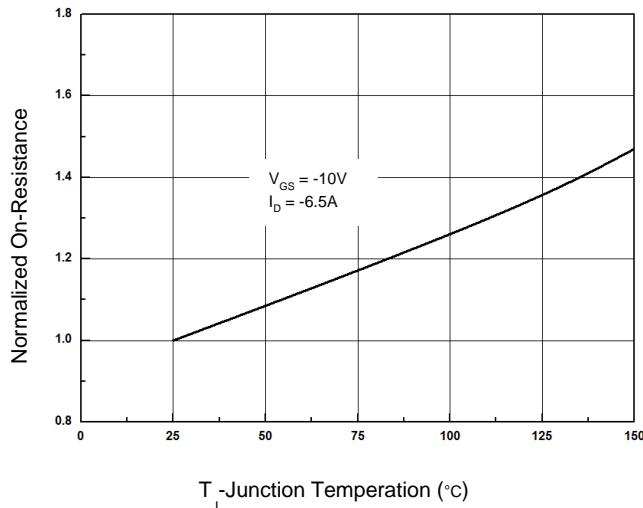


Figure 9. BVdss vs. Junction temperature(°C)

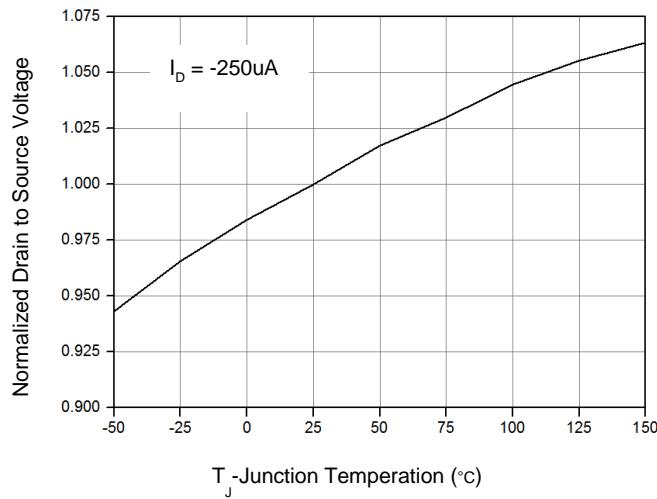


Figure 8. Rds(on) vs Gate Voltage

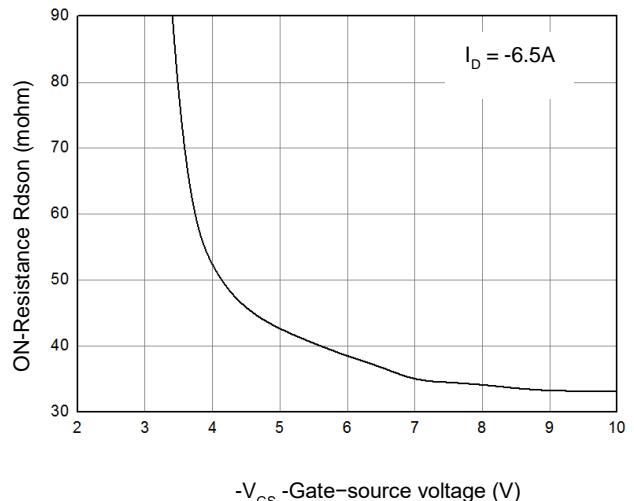


Figure 10. Maximum Safe Operating Area

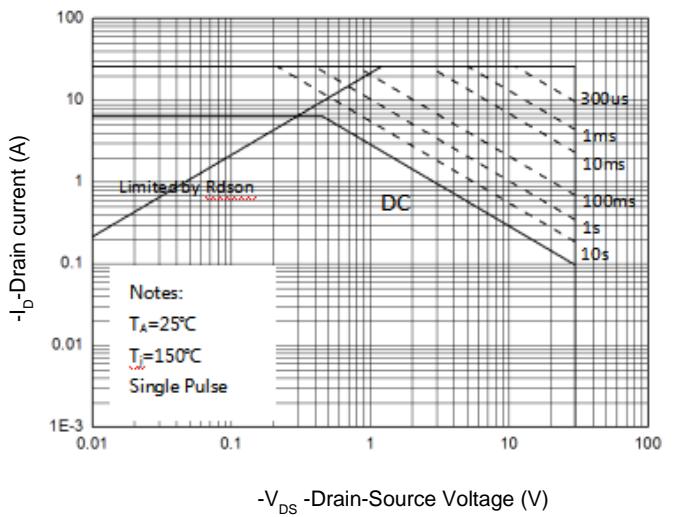
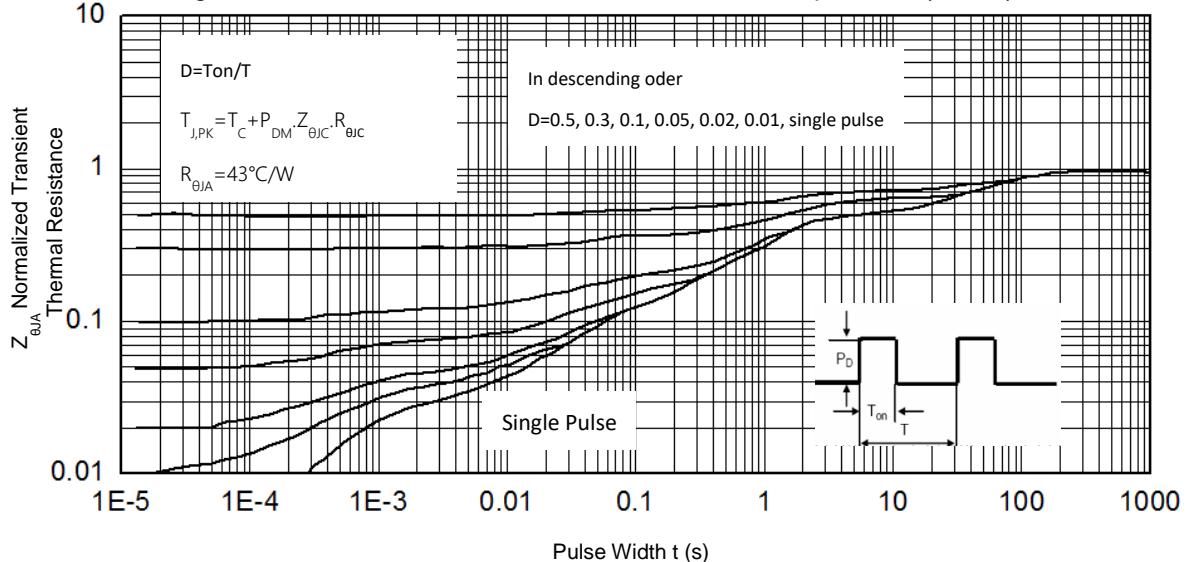


Figure 11. Normalized Maximum Transient Thermal Impedance (RthJA)



Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform

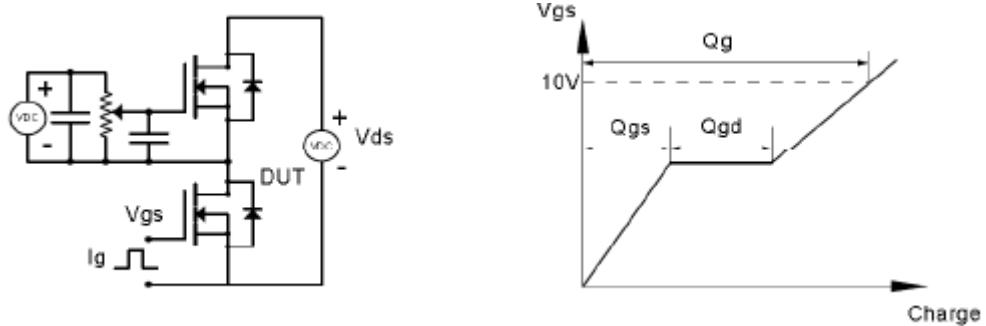


Figure 9. Resistive Switching Test Circuit & Waveforms

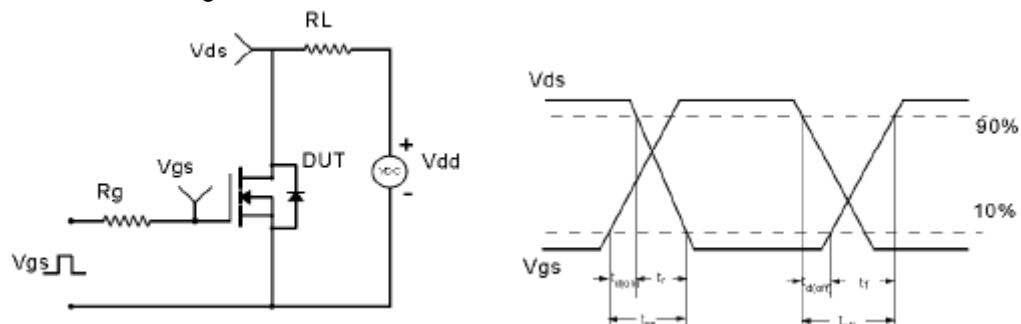


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

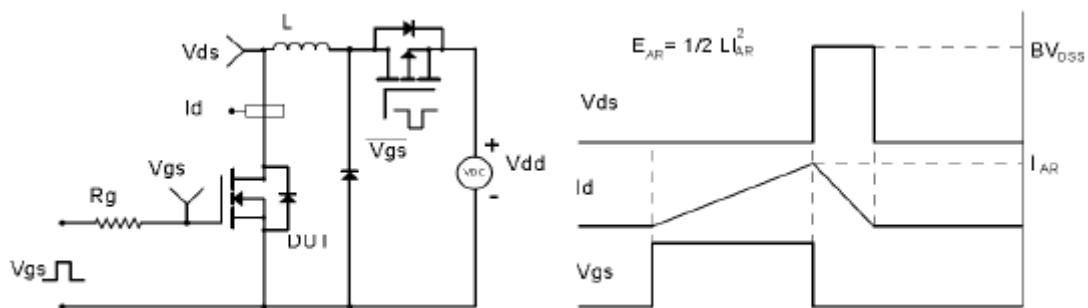
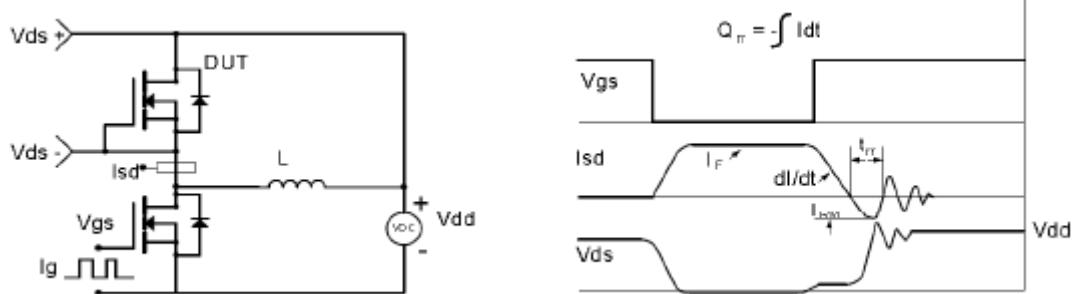
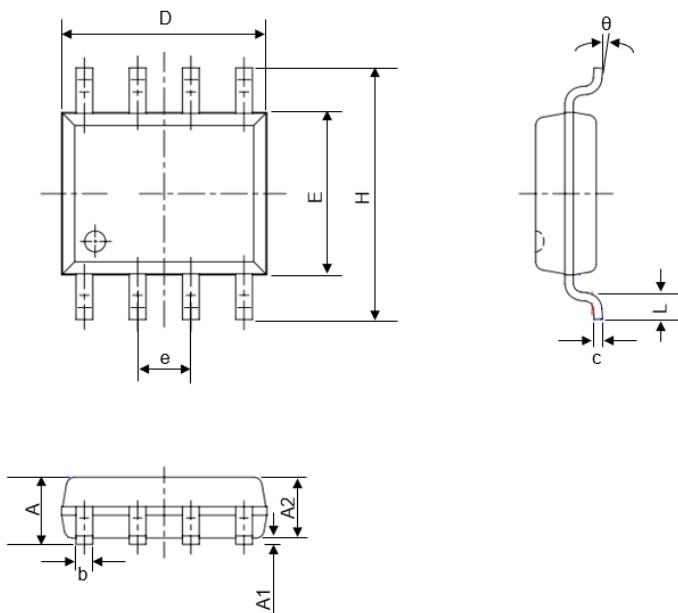


Figure 11. Diode Recovery Circuit & Waveform

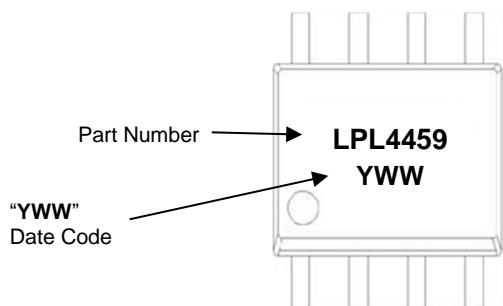


Mechanical Dimensions for SOP-8



SYMBOL	COMMON DIMENSIONS			
	MILLIMETERS		INCHS	
	MIN	MAX	MIN	MAX
A	1.45	1.75	0.057	0.069
A1	0.05	0.25	0.002	0.010
A2	1.35	1.55	0.053	0.061
b	0.35	0.45	0.014	0.018
c	0.19	0.27	0.007	0.011
D	4.80	5.00	0.189	0.197
E	3.78	3.98	0.149	0.157
e	1.27 TYP.		0.050 TYP.	
H	5.80	6.20	0.228	0.244
L	0.40	1.00	0.016	0.039
θ	0°	8°	0°	8°

SOP-8 Part Marking Information



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